

Date	Topic of lecture	Exercise (H=home; S=spot)	Teacher	Readings for this lecture
27 Feb	Introduction Litho & etching Silicon		SF SF VO	Introduction to Microfabrication Chapter 1 Chapters 9,11 Chapter 4 Chapters 12,35 Chapter 5 Chapters 12, 35
5 March	Cleaning & cleanroom & safety Lab device (sputtering)	S1: Thin film, litho & etch LAB REGISTRATION STARTS	VO, SF	
12 March	Oxidation Thin films	H1: thin film, litho, etch	MA VO SF	Chapter 13
19 March	Doping (incl. Epi)	FIRST GROUP IN LAB MARCH XX H2: resistors, caps	LM VO VO, SF	Chapters 6,14,15
26 March	Bonding & CMP Integration	H3: oxide, doping LAST GROUP IN LAB XXX	LM VO SF	Chapters 16,17 Chapter 25
2 April	Easter holiday			
9 April		H4: lab reports discussed	MM	
	MEMS 1 (etch)		SF	Chapters 21,22
		S3: MEMS 1	SF	
16 April	exam week, no teaching			
23 April	CMOS	H5: MEMS 1	MM	
			VO	Chapter 26
25 April	MEMS 2 (bulk)	S4: CMOS starters H6: CMOS	VO	
Thursday			SF	Chapter 30
		S5: MEMS 2	SF	
30 April	Yield & reliability Nano-CMOS, metallization & Moore's law		VO VO	Chapter 36 Chapters 28,38
		S6: metallization	VO	
7 May	MEMS 3 (surface)	H7: yield; economics	VO	
			SF	Chapter 29
14 May	Scaling Economics of microfabrication	S7: MEMS 3 H8: MEMS 3	SF SF	Chapter 25, 38
	Q&A session		VO, SF	
21 May	Exam	time: 9-12 o'clock	all	